

## First Results of the Performance of CMS **HGCAL Modules with Neutron Irradiated** Silicon Sensors Wesley Terrill on behalf of the CMS HGCAL Collaboration







- ~620  $m^2$  of silicon sensors + ~487  $m^2$  of scintillator
- Tests of the end-of-life conditions of the Si-Sensors to understand expected loss in charge
- collection efficiency and increases in leakage current and noise
  - Cold operation and annealing periods to partially mitigate the leakage current
- HGCROC chips include a leakage current (I) DAC that can mitigate up to  $40~\mu A$  per cell of leakage current
- · High Density (HD) thin sensors used where radiation is harsher
  - + 8-inch  $120 \mu m$  thick sensor with  ${\sim}450$  channels of cell size  ${\sim}0.5~cm^2$
  - Tested Modules built with irradiated sensors corresponding to 3-4 ab<sup>-1</sup> scenarios + Fluences of  $1.0*10^{16}\;n_{eq}/cm^2$  and  $1.4*10^{16}\;n_{eq}/cm^2$





module has several layers built on top of one r. PCB backplate followed by Kapton foil and t ensor. The top layer contains the electronics lated with data acquisition from the HGCROCs

## 2) Experimental Setup

- Module tested on temperature-controlled chuck, held in place by vacuum
- Measured leakage current vs bias voltage (IV)
- Compared to bare IV sensor at a temperature of  $-40^\circ\mathrm{C}$
- Expect temperature offset between cold chuck and the silicon sensor inside the module · PCB baseplate and kapton foil in-between sensor and temperature chuck
- "IDAC"- Channel-wise parameter controlling the current compensation level to prevent ADC saturation due to leakage current
- Mitigates electronic noise
- IDAC level per channel calibrated to give target pedestal level (~150 ADC) for all measurements as recommended by the chip developers
- Reoptimized IDAC for all measurement configurations







Zoomed in view of the LDO and

The experimental setup for testing irradiated modules

3) Light Injection



ADC Level after light injected into one cell of the module @1.0e16 n<sub>eg</sub>/cm<sup>2</sup>. Three HGCROCs left unpowered due to powering issue or module during light inject ion measu

- Light injected into a single cell from laser through holes in the PCB hexaboard
- Check for cross-talk between nearby cells Synchronized triggers to laser driver and DAQ at 1 kHz rate
- Missing channels due to powering issue of 3 HGCROCs during data taking period
- Injected channel signal peak at ~550 ADC (non-saturated) No evidence of cross-talk between nearby channels

8 2.25 1.25



2 z.z



The orange curves display the module leakage currents rescaled assuming an average temperature difference of  $3.5^{\circ}$ C (TOP) for the module @1.4e16  $n_{eq}/cm^2$  and  $2.0^{\circ}$ C (BOTTOM) for the module @1.0e16 neg/cm2

4) Noise Dependency on Bias Voltage

with respect to other sources

bias voltage ( $V_{bias}$ )

Expect sub-leading contribution to noise from leakage current

Optimal operation and power considerations may require tuning

· Difference in noise level observed between the two modules

Increase of the radiation damage constant with V<sub>bias</sub>

 Very small increase in the noise level is observed Noise level constant throughout changes in operational  $V_{bias}$ 

Temperature shift extrapolation for an example cell of the module O.0e16  $n_{eq}/cm^2$ . The IDAC values from different temperatures are used to fit an Arrhenius curve with respect to the given cells bare server measurement

- At each temperature, the IDAC is optimized to mitigate the noise + Convert the measurement of the  $\mathbf{I}_{leak}$  current
  - Perform a combined fit to extract the individual temperature of each cell
- Temperature profile identifies hot spots in a module coinciding with the HGCROCs and LDOs positions
- · HGCROCs and LDOs generate heat on surface of module
- Average temperature shift of all cells found to be  $2.0^\circ \text{C}$  and  $3.5^\circ \text{C}$
- · Different temperature shifts between sensors under investigation
- · Used as input for more detailed FEA analyses and final modeling and implementation of cassette cooling



IDAC value (LEFT) and the extracted temperature (RiGHT) maps for modules @1.4e16  $n_{eq}/cm^2$  (TOP) and @1.0e16  $n_{eq}/cm^2$  (BOTTOM). The chuck temperature is assumed to be set to -40°C and bias voltage set to 600 °C. The cell temperature is then calculated for end. temperature shift calculated per cell.

## 6) Summary

- First measurements with heavily irradiated HD modules built with close to final electronics layout
- No evidence of cross-talk with data taken from light injection
- Noise level under control in both temperature and voltage measurements
- Current compensation by HGCROC in HD modules tested and validated, used to estimate temperature map

## 7) References

The CMS Collaboration. (2017). The Phase-2 Upgrade of the CMS Endcap Calorimeter. doi:10.17181/CERN.IV8M.1JY2